Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

06/02/2022

Details for "LMR36015ARNXT"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LMR36015ARNXT	SN	Level-2-260C-1 YEAR	Fxt-Mfg	RNX 12	3x2x0.9	13.3

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB	
Yes	Yes	Yes	Yes	

Component Information

	Homogeneous Material Level			neous Material Level	Component Level		
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	4.579882	97.444277	974443	34.343181	343432
Copper and Its Alloys	Iron	7439-89-6	0.110398	2.348893	23489	0.827842	8278
Copper and Its Alloys	Phosphorus	7723-14-0	0.00386	0.082128	821	0.028945	289
Zinc and Its Alloys	Zinc	7440-66-6	0.005861	0.124702	1247	0.04395	439
Sub-Total			4.700001	100	1000000	35.243918	352439
Lead Frame Plating							
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.06	100	1000000	0.449922	4499
Sub-Total			0.06	100	1000000	0.449922	4499
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	5.263863	90.999997	910000	39.472153	394722
Other Plastics and Rubber	Carbon Black	1333-86-4	0.028922	0.499994	5000	0.216878	2169
Thermoplastics	Ероху	85954-11-6	0.49168	8.500008	85000	3.686963	36870
Sub-Total			5.784465	100	1000000	43.375993	433760
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	2.655392	100	1000000	19.912	199120
Sub-Total			2.655392	100	1000000	19.912	199120
Solder Bump							
Copper and Its Alloys	Copper	7440-50-8	0.119648	88.119665	881197	0.897205	8972
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.015316	11.280095	112801	0.11485	1149
Precious Metals	Silver	7440-22-4	0.000815	0.60024	6002	0.006111	61
Sub-Total			0.135779	100	1000000	1.018167	10182
							1
Total			13.335637			100	1000000

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component. See Glossary of Terms for more details.

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

Ti bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. Ti may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 06/02/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.